



HOLE IN PCB $\phi 1.55^{+0.05}_{-0}$
HOLE IN HEAT SINK $\phi 1.7^{+0.2}_{-0}$

- NOTE: 1. THE COLOR BATCH TEST REPORT IS ONLY FOR TEST PURPOSE.
色母環保檢測報告, 僅提供原始測試報告.
2. SHRINKING IS NORMAL STATUS.
內縮屬正常現象.
3. MADE OF EQUIVALENT MATERIAL.
可使用同等材質.



康揚企業股份有限公司
KANG YANG HARDWARE ENTERPRISE CO., LTD.
康揚塑膠(東莞)有限公司
KANG YANG PLASTIC(DONG GUAN)CO., LTD.
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DO NOT SCALE DRAWING

DATE
2009.07.24

DRAWN
Eric

CHECKED
[Signature]

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TITLE
HEAT SINK RIVET

MATERIAL
PC+ABS UL94V-0

COLOR
BLACK

FINISH
UNLESS OTHERWISE SPECIFIED
TOLERANCE: SEE ABOVE

DWG. NO.

HSR-37APBV

SIZE
A4

SCALE: 5:1

PART NO.

HSR-37APBV

SPEC. DWG.

REV
A

UNIT
mm

SHEET 1 OF 1